

ZPMV2.E357163 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

**KING CREDIE TECHNOLOGY LTD**  
Unit A1, 7/F, Cheuk Nang Plaza  
250 Hennessy Road  
Waichai, HONG KONG

E357163

Type	Cond Width		Cond Thk mic(mil)	SS/ DS/ DSO	Max Area Diam mm(in)	Solder		Max Oper		Meets UL796 DSR	C T I
	Min	Edge				Limits	Temp	Flame			
	mm(in)	mm(in)				C	sec	C	Class		
	Multilayer printed wiring boards.										
MJD-M	0.09 (0.004)	0.09 (0.004)	18 (0.71) Int:102	DS	50.8 (2.0)	288	20	130	V-0	All	*
Single layer printed wiring boards.											
MJD-D	0.09 (0.004)	0.09 (0.004)	18 (0.71)	DS	50.8 (2.0)	288	20	130	V-0	All	*

\* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

Last Updated on 2018-01-14

The appearance of a company's name or product in this database does not in itself assure that products so identified have been manufactured under UL's Follow-Up Service. Only those products bearing the UL Mark should be considered to be Certified and covered under UL's Follow-Up Service. Always look for the Mark on the product.

UL permits the reproduction of the material contained in the Online Certification Directory subject to the following conditions: 1. The Guide Information, Assemblies, Constructions, Designs, Systems, and/or Certifications (files) must be presented in their entirety and in a non-misleading manner, without any manipulation of the data (or drawings). 2. The statement "Reprinted from the Online Certifications Directory with permission from UL" must appear adjacent to the extracted material. In addition, the reprinted material must include a copyright notice in the following format: "© 2019 UL LLC"

- [Your Privacy](#)
- [Strictly Necessary Cookies](#)
- [Performance Cookies](#)
- [Targeting Cookies](#)
- [More Information](#)